

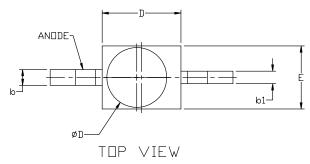


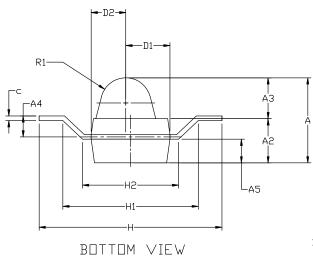
T-3/4 2.50x2.00 CASE 100EG ISSUE O

**DATE 14 SEP 2023** 

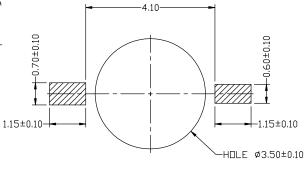
## NOTES:

- 1. CONTROLLING DIMENSIONS: MILLIMETERS
- 2. DIMENSIONS DO NOT INCLUDE MOLD FLASH OR BURRS.
- 3. 2MM ZBEND LED RP.





DIM	MILLIMETERS			
	MIN.	N□M.	MAX.	
А	2.500	2.700	2.900	
A2	1.300	1.400	1.500	
АЗ	1.200	1.300	1.400	
Α4	0.550	0.650	0.750	
A5	0.650	0.750	0.850	
р	0.450	0,550	0.650	
b1	0.350	0.450	0.550	
C	0.100	0.150	0.200	
D	2.300	2.500	2.700	
D1	1.200	1.400	1.600	
D2	0.900	1.100	1.300	
E	1,800	2,000	2,200	
Н	5.600	5.800	6.000	
H1	4.100	4.300	4.500	
H2	2.850	3,050	3.250	
ØD	1.700	1.900	2.100	
R1	0.700	0.800	0.900	



## RECOMMENDED MOUNTING FOOTPRINT\*

\*FOR ADDITIONAL INFORMATION ON OUR Pb-FREE STRATEGY AND SOLDERING DETAILS, PLEASE DOWNLOAD THE ON SEMICONDUCTOR SOLDERING AND MOUNTING TECHNIQUES REFERENCE MANUAL, SOLDERRM/D.

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